



Capsule Thyristor

V_{RSM}	V_{RRM}, V_{DRM}	$I_{TRMS} = 1000 \text{ A}$ (maximum value for continuous operation)
V	V	$I_{TAV} = 490 \text{ A}$ (sin. 180; DSC; $T_c = 80 \text{ }^\circ\text{C}$)
500	400	SKT 491/04E
1300	1200	SKT 491/12E
1500	1400	SKT 491/14E
1700	1600	SKT 491/16E
1900	1800	SKT 491/18E

Line Thyristor

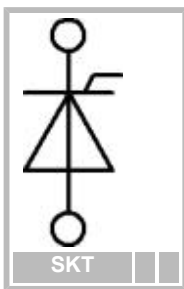
SKT 491

Features

- Hermetic metal case with ceramic insulator
- Capsule package for double sided cooling
- Shallow design with single sided cooling
- International standard case
- Off-state and reverse voltages up to 1800 V
- Amplifying gate

Typical Applications

- DC motor control (e. g. for machine tools)
- Controlled rectifiers (e. g. for battery charging)
- AC controllers (e. g. for temperature control)
- Recommended snubber network e. g. for $V_{VRMS} \leq 400 \text{ V}$:
 $R = 33 \cdot 32 \text{ W}, C = 0,47 \cdot \text{F}$



Symbol	Conditions	Values	Units
I_{TAV}	sin. 180; $T_c = 100 (85) \text{ }^\circ\text{C}$	321 (452)	A
I_D	$2 \times \text{P8/180}; T_a = 45 \text{ }^\circ\text{C}; \text{B2 / B6}$	320 / 450	A
	$2 \times \text{P8/180F}; T_a = 35 \text{ }^\circ\text{C}; \text{B2 / B6}$	760 / 1000	A
I_{RMS}	$2 \times \text{P8/180}; T_a = 45 \text{ }^\circ\text{C}; \text{W1C}$	350	A
I_{TSM}	$T_{vj} = 25 \text{ }^\circ\text{C}; 10 \text{ ms}$	8000	A
	$T_{vj} = 125 \text{ }^\circ\text{C}; 10 \text{ ms}$	7000	A
i^2t	$T_{vj} = 25 \text{ }^\circ\text{C}; 8,3 \dots 10 \text{ ms}$	320000	A^2s
	$T_{vj} = 125 \text{ }^\circ\text{C}; 8,3 \dots 10 \text{ ms}$	245000	A^2s
V_T	$T_{vj} = 25 \text{ }^\circ\text{C}; I_T = 1500 \text{ A}$	max. 2,1	V
$V_{T(TO)}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	max. 1,1	V
r_T	$T_{vj} = 125 \text{ }^\circ\text{C}$	max. 0,7	$\text{m}\bullet$
$I_{DD}; I_{RD}$	$T_{vj} = 125 \text{ }^\circ\text{C}; V_{RD} = V_{RRM}; V_{DD} = V_{DRM}$	max. 50	mA
t_{gd}	$T_{vj} = 25 \text{ }^\circ\text{C}; I_G = 1 \text{ A}; di_G/dt = 1 \text{ A}/\mu\text{s}$	1	μs
t_{gr}	$V_D = 0,67 \cdot V_{DRM}$	1	μs
$(di/dt)_{cr}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	max. 125	$\text{A}/\mu\text{s}$
$(dv/dt)_{cr}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	max. 1000	$\text{V}/\mu\text{s}$
t_q	$T_{vj} = 125 \text{ }^\circ\text{C}$	50 ... 150	μs
I_H	$T_{vj} = 25 \text{ }^\circ\text{C}; \text{typ. / max.}$	150 / 500	mA
I_L	$T_{vj} = 25 \text{ }^\circ\text{C}; R_G = 33 \text{ } \Omega; \text{typ. / max.}$	500 / 2000	mA
V_{GT}	$T_{vj} = 25 \text{ }^\circ\text{C}; \text{d.c.}$	min. 3	V
I_{GT}	$T_{vj} = 25 \text{ }^\circ\text{C}; \text{d.c.}$	min. 250	mA
V_{GD}	$T_{vj} = 125 \text{ }^\circ\text{C}; \text{d.c.}$	max. 0,25	V
I_{GD}	$T_{vj} = 125 \text{ }^\circ\text{C}; \text{d.c.}$	max. 10	mA
$R_{th(j-c)}$	cont.; DSC	0,045	K/W
$R_{th(j-c)}$	sin. 180; DSC / SSC	0,047 / 0,1	K/W
$R_{th(j-c)}$	rec. 120; DSC / SSC	0,054 / 0,113	K/W
$R_{th(c-s)}$	DSC / SSC	0,012 / 0,024	K/W
T_{vj}		- 40 ... + 125	$^\circ\text{C}$
T_{stg}		- 40 ... + 130	$^\circ\text{C}$
V_{isol}		-	V~
F	mounting force	5,2 ... 8	kN
a			m/s^2
m	approx.	105	g
Case		B 11	

Diagrams

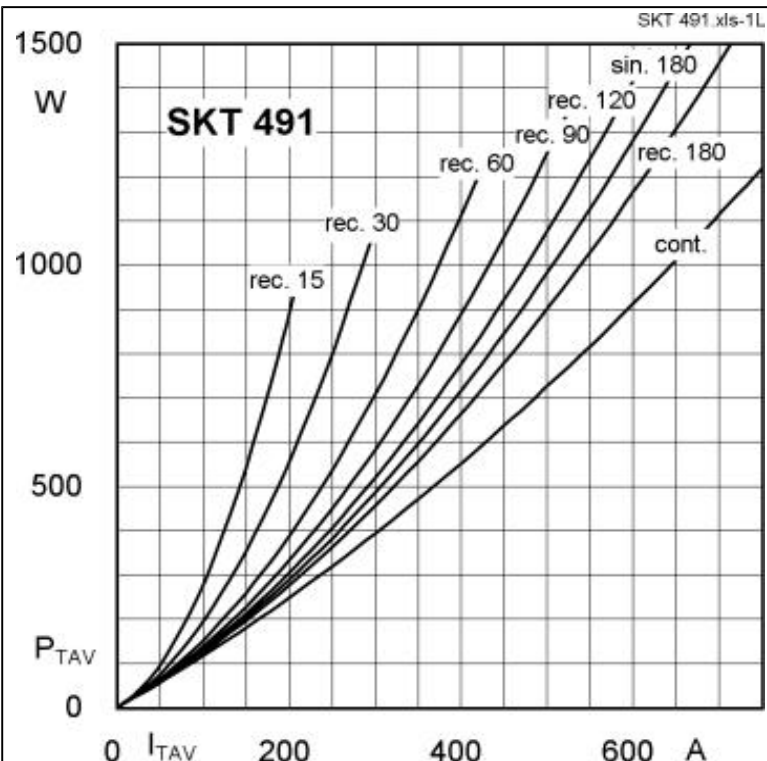


Fig. 1L Power dissipation vs. on-state current

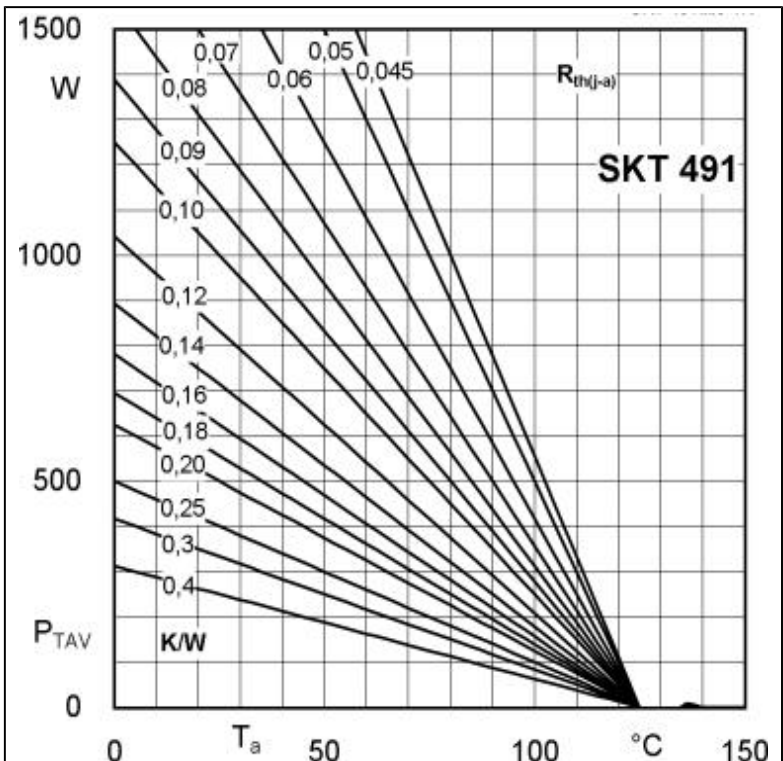


Fig. 1R Power dissipation vs. ambient temperature

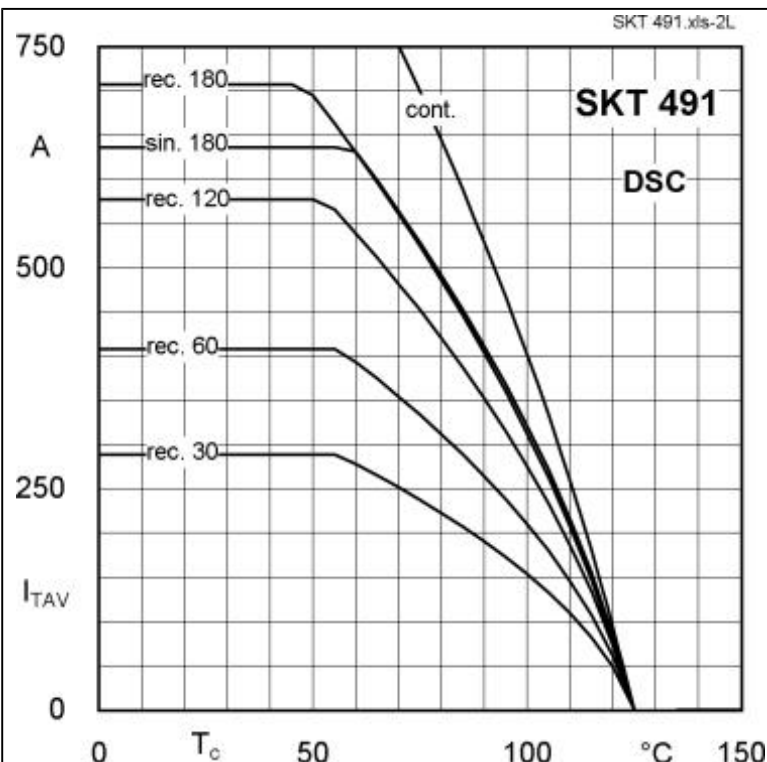


Fig. 2L Rated on-state current vs. case temperature

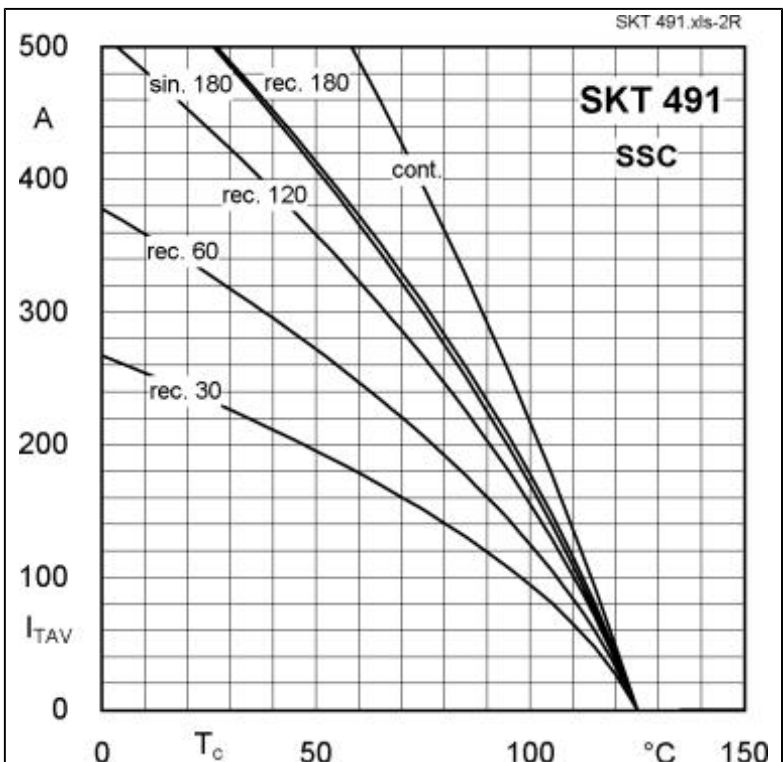


Fig. 2R Rated on-state current vs. case temperature

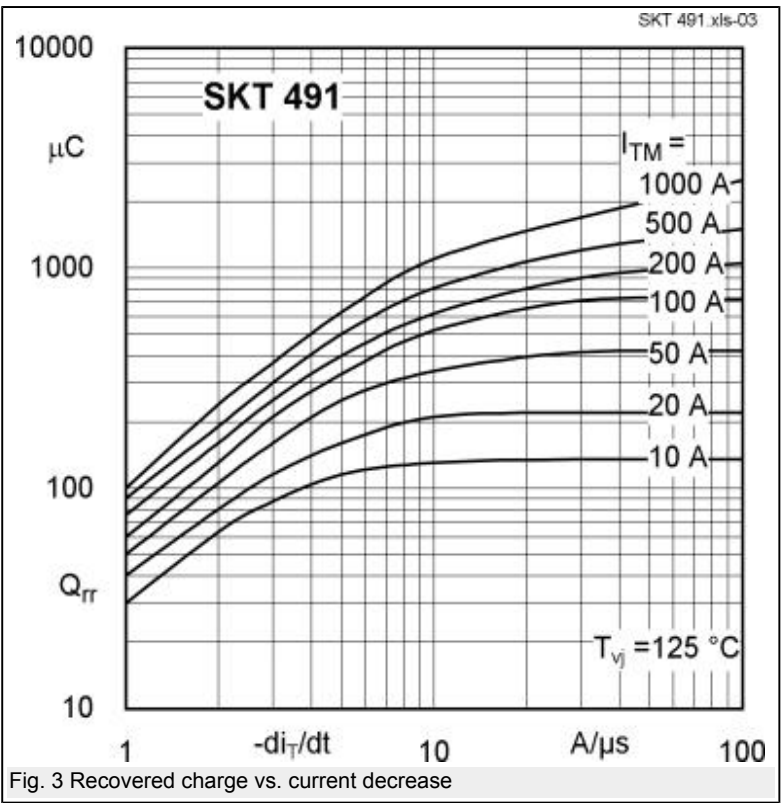


Fig. 3 Recovered charge vs. current decrease

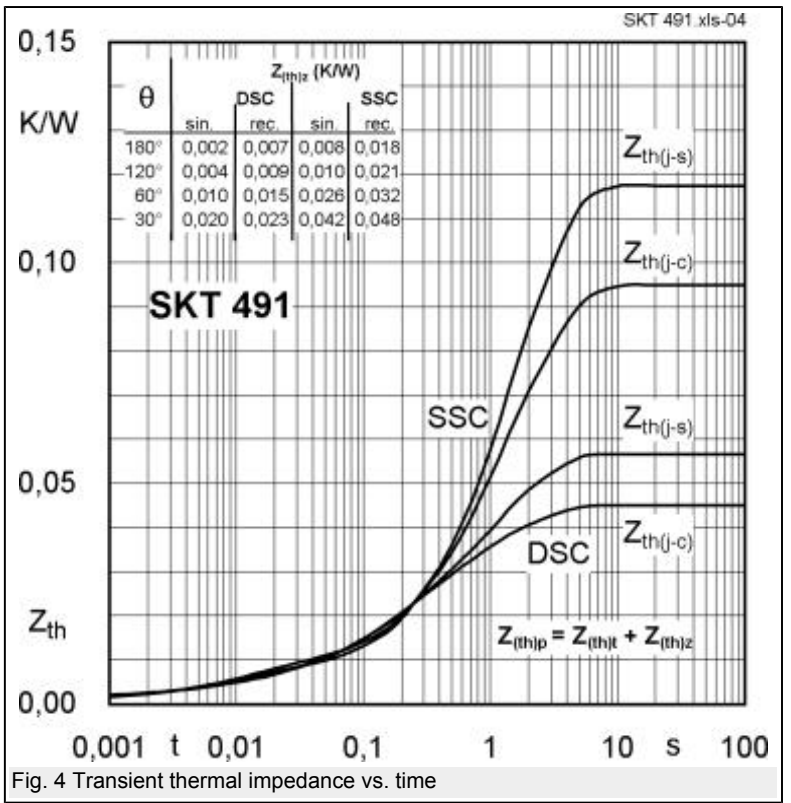


Fig. 4 Transient thermal impedance vs. time

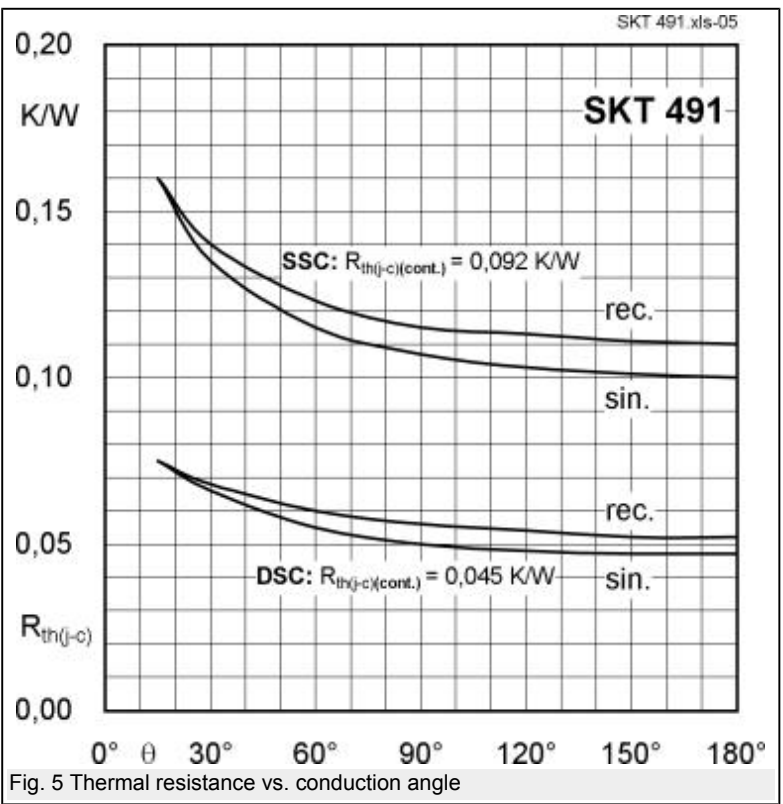


Fig. 5 Thermal resistance vs. conduction angle

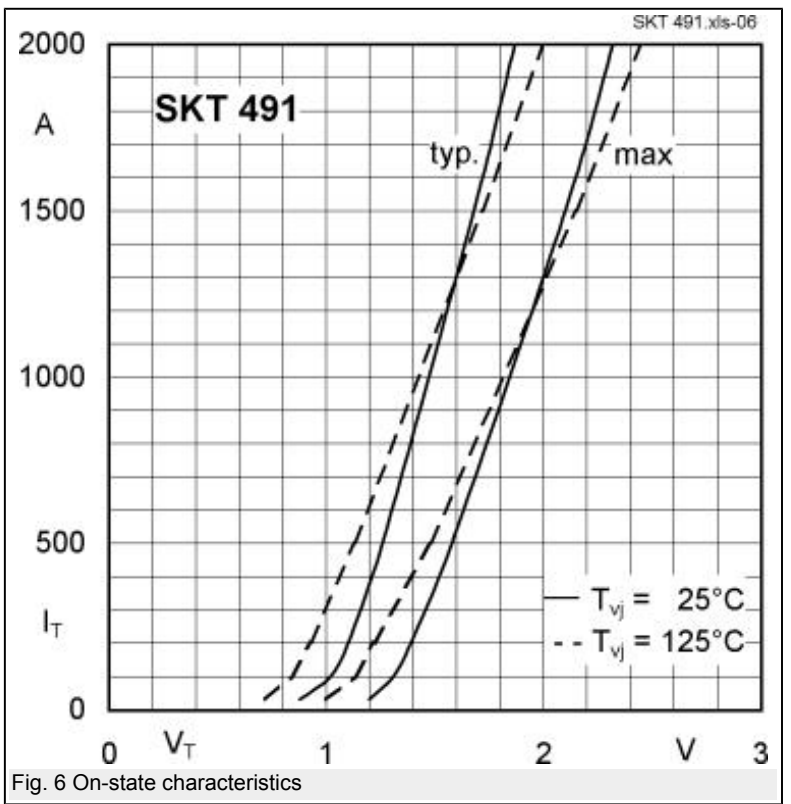
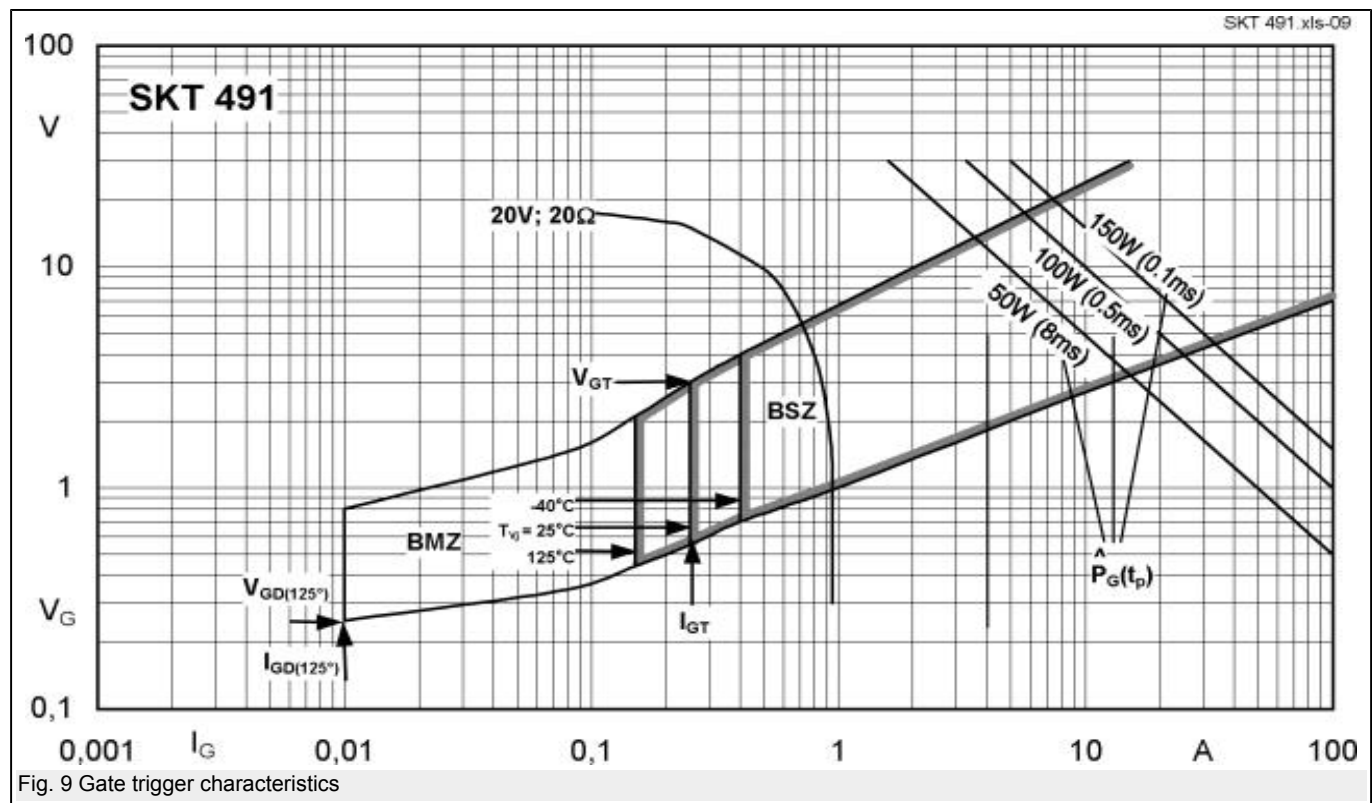
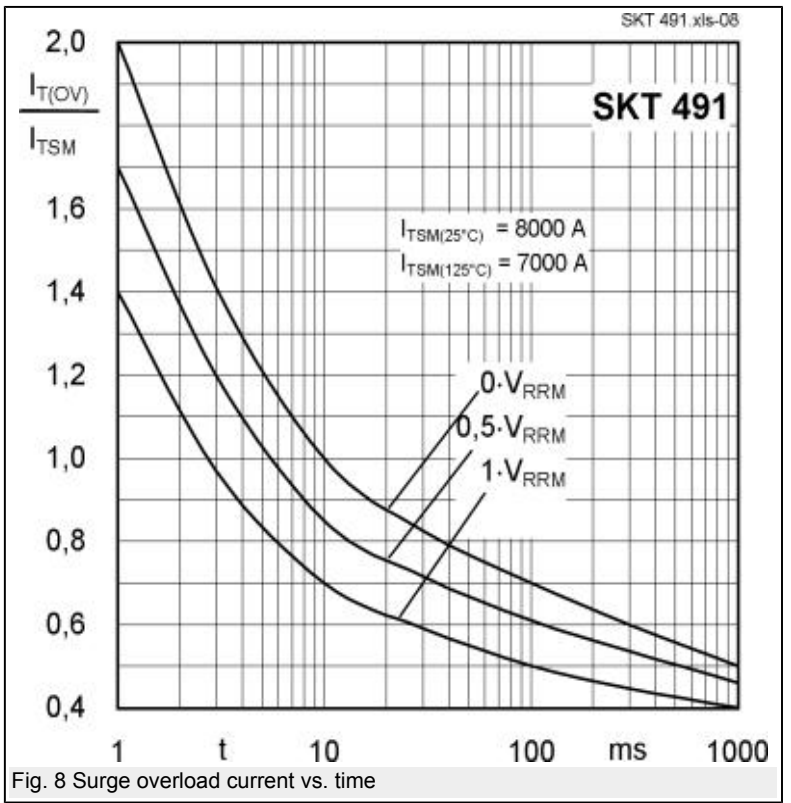
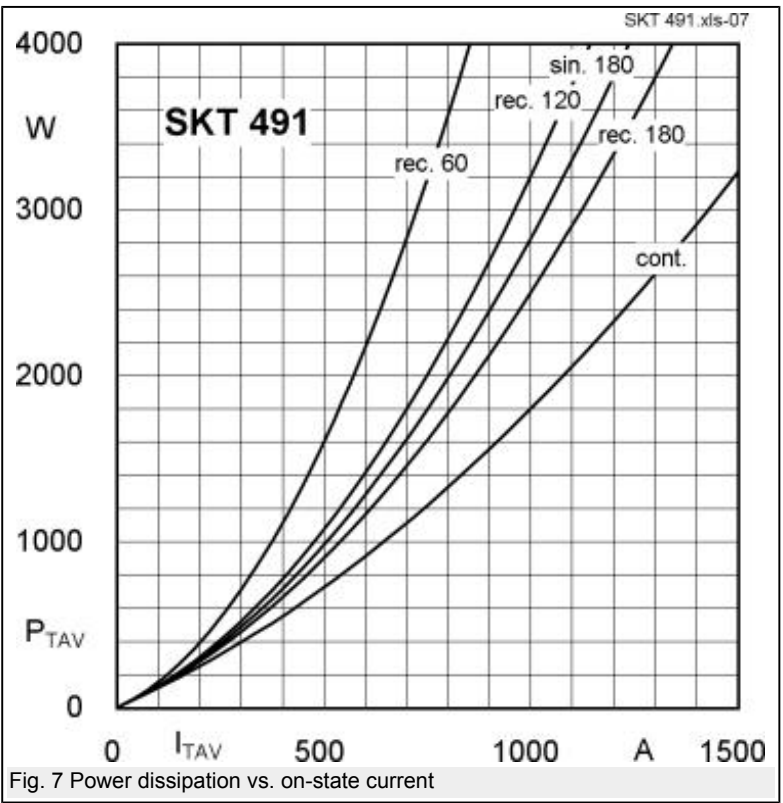
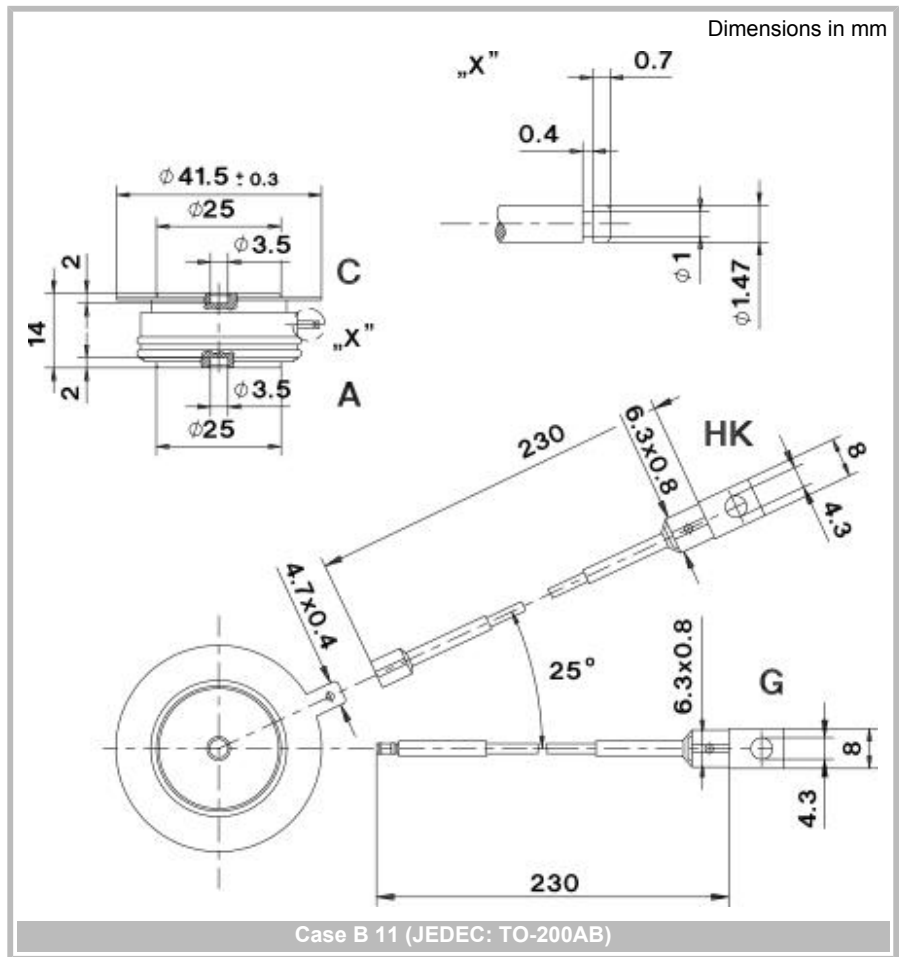


Fig. 6 On-state characteristics



Cases / Circuits



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